



Electronic Information Disclosure Statement


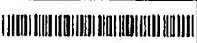

LEAKAGE FREE CERAMIC FILMS FOR POROUS SURFACES

Application: 
10/064588
Confirmation: 5119
Applicant(s): Zhonglin Wu
Docket Number: 000115-210
Group Art Unit: 1741
Examiner:
search string: (5871624 or 5985113 or 6382958).pn.

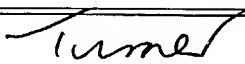
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US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Citation No.	Patent Number	Date	Bar Code	Patentee	Class	Subclass
<input checked="" type="checkbox"/>	P01	5871624	1999-02-16		Crome	204	286.1
<input checked="" type="checkbox"/>	P02	5985113	1999-11-16		Crome et al.	205	343
<input checked="" type="checkbox"/>	P03	6382958	2002-05-07		Bool, III et al.	431	2

Signature


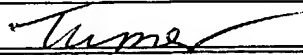
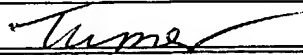
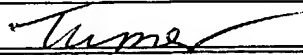
Examiner Name	Date
	02/04



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	LEAKAGE FREE CERAMIC FILMS FOR POROUS SURFACES																														
Application Number:		10/064588																													
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First Named Applicant:		Zhonglin WU																													
Attorney Docket Number:		000115-210																													
Art Unit:		1775																													
Examiner:		Archene Turner																													
Search string:		(6383350 or 6284682).pn.																													
<p><u>Certification:</u> This Information Disclosure Statement was submitted under the following conditions, which satisfies the requirement under 37 CFR 1.97(e). The filer certified:</p> <p>That each item of information contained in the information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement.</p> <p>US Patent Documents</p> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td><input checked="" type="checkbox"/></td><td>1</td><td>6383350</td><td>2002-07-05</td><td>Sehlin et al.</td><td></td><td>204</td><td>286.1</td></tr><tr><td><input checked="" type="checkbox"/></td><td>2</td><td>6284682</td><td>2001-09-04</td><td>Troczynski et al.</td><td></td><td>501</td><td>12</td></tr></tbody></table>								init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass	<input checked="" type="checkbox"/>	1	6383350	2002-07-05	Sehlin et al.		204	286.1	<input checked="" type="checkbox"/>	2	6284682	2001-09-04	Troczynski et al.		501	12
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